



# LC74401E, 74402, 74402E

## PIP Controllers

### Overview

The LC74401E, LC74402, and LC74402E are memory controllers for TV set and VCR PIP (picture in picture) systems. Since these LSIs include three D/A converter circuits, a component PIP system can be constructed by combining one of these LSIs with memory and an A/D converter such as the LC7480.

### Features

- Horizontal resolution: 600 TV lines\*1
  - Three D/A converters (for the Y, R-Y, and B-Y signals) are incorporated in the PIP memory controller block.
  - High image quality is supported by vertical filter function frame memory processing\*2.
  - I<sup>2</sup>C bus controlled.
  - Built-in PLL circuit (requires an external LPF)
  - Supports NTSC, PAL, and multiple (NTSC-PAL) formats
  - External control functions (only provided by the LC74401E)
    - 8-bit D/A converter (PWM): Six pins
    - General-purpose ports: Four pins
  - Sub-screen specifications
    - Number of sub-screens: 1-8\*2
    - Display on/off and frame on/off/color switching, wipe function
    - Supports switching between fixed (4 corners) and arbitrary (8-bit specification of vertical and horizontal position) display positions.
    - Size: Area: 1/4, 1/9, 1/16, Vertical compression: 1/2, 1/3, 1/4; Horizontal compression: 2/3, 1/3, 1/6
- Note: Horizontal compression can be adjusted by changing the PLL divisor.

The display area can be changed independently in the vertical and horizontal directions.

— Horizontal resolution (Y signal): About 250 dots

— Gradation (quantization): 64 (6 bits)

- Operating supply voltage: 5 V ± 10%
- QFP80E: LC74401E
- DIP64S: LC74402-Pin assignment identical to the LC7442 (except for the serial control pins)
- QFP64E: LC74402E-Pin assignment identical to the LC7442E (except for the serial control pins)

Note 1

	D/A Clock
Y	15.00 MHz
R-Y	3.75 MHz
B-Y	3.75 MHz

When the main screen synchronization PLL has the standard value (PLL7 to PLL3 = 10011)

Note 2: The specifications depend on the amount of external memory as listed in the table below.

Display memory	256 K	1 M
One screen	△	○
Two screens	X	○
Three screens	X	△
Four screens	X	△

○: Frame display of both dynamic and static images supported. (Frame memory processing)

△: Frame display of dynamic images only supported.

X: Not supported.

Note: The number of sub-screens listed in the table above are doubled in split mode. (However, image quality is reduced.)

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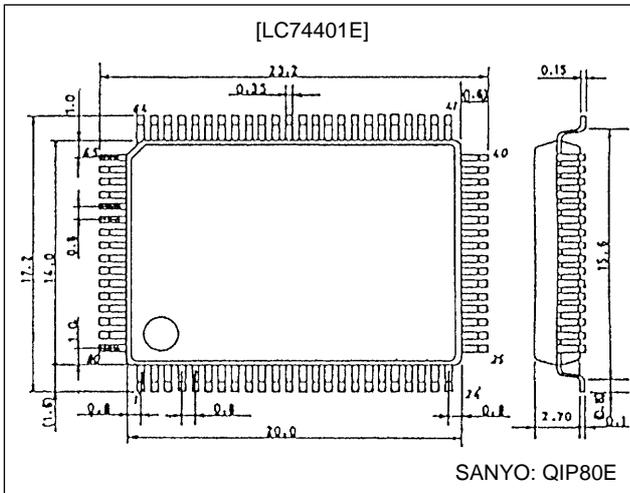
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LC74401E, 74402, 74402E

Package Dimensions

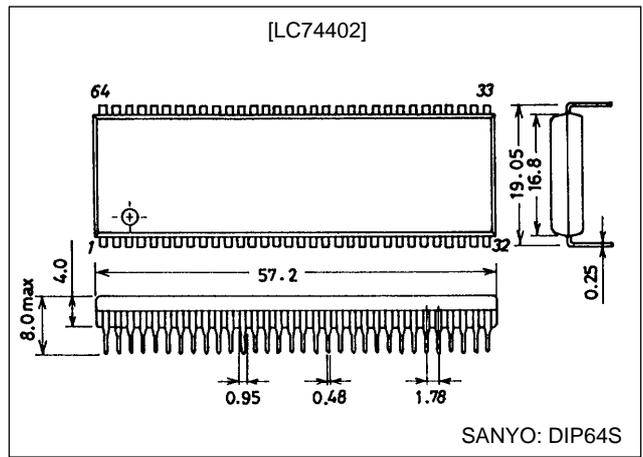
unit: mm

3074-QFP80E



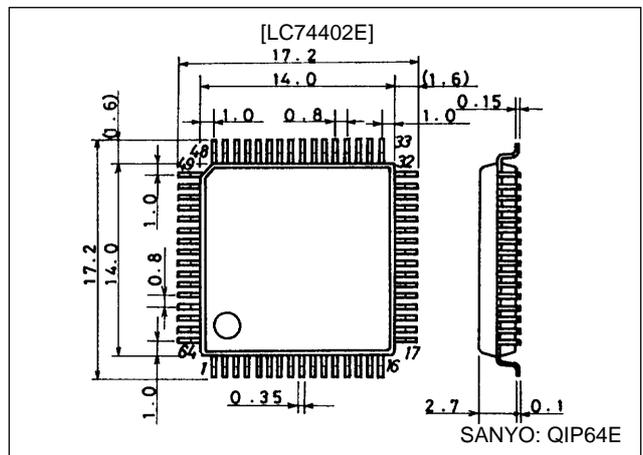
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3071-DIP64S

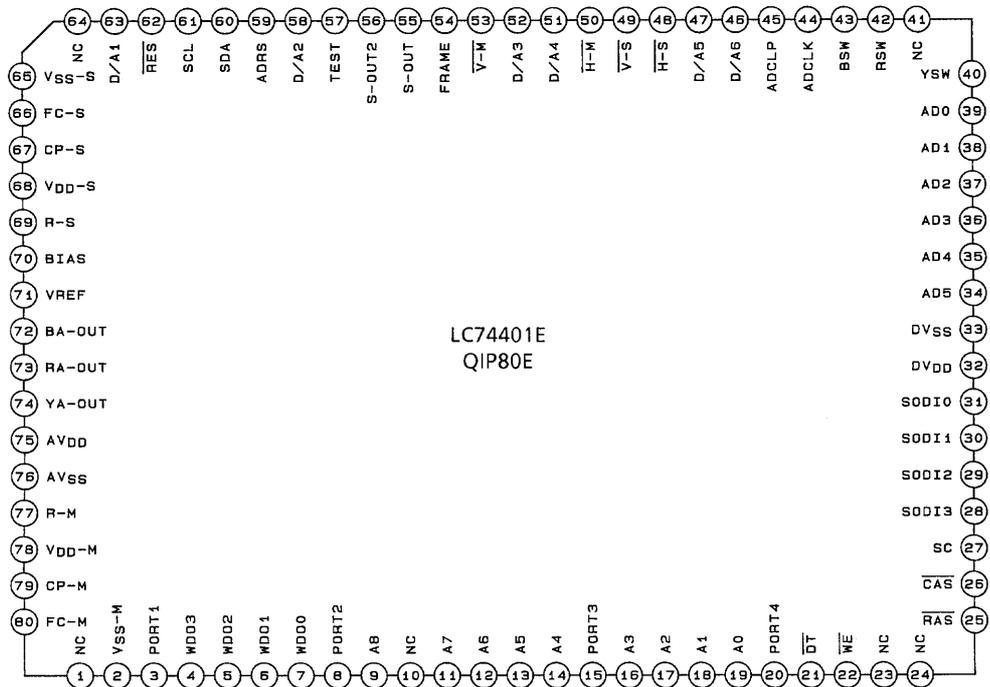


unit: mm

3159-QFP64E

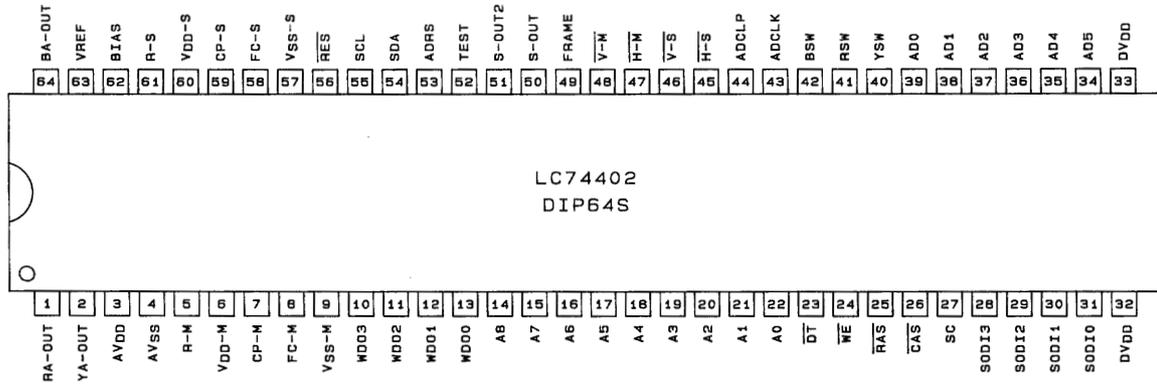


Pin Assignments

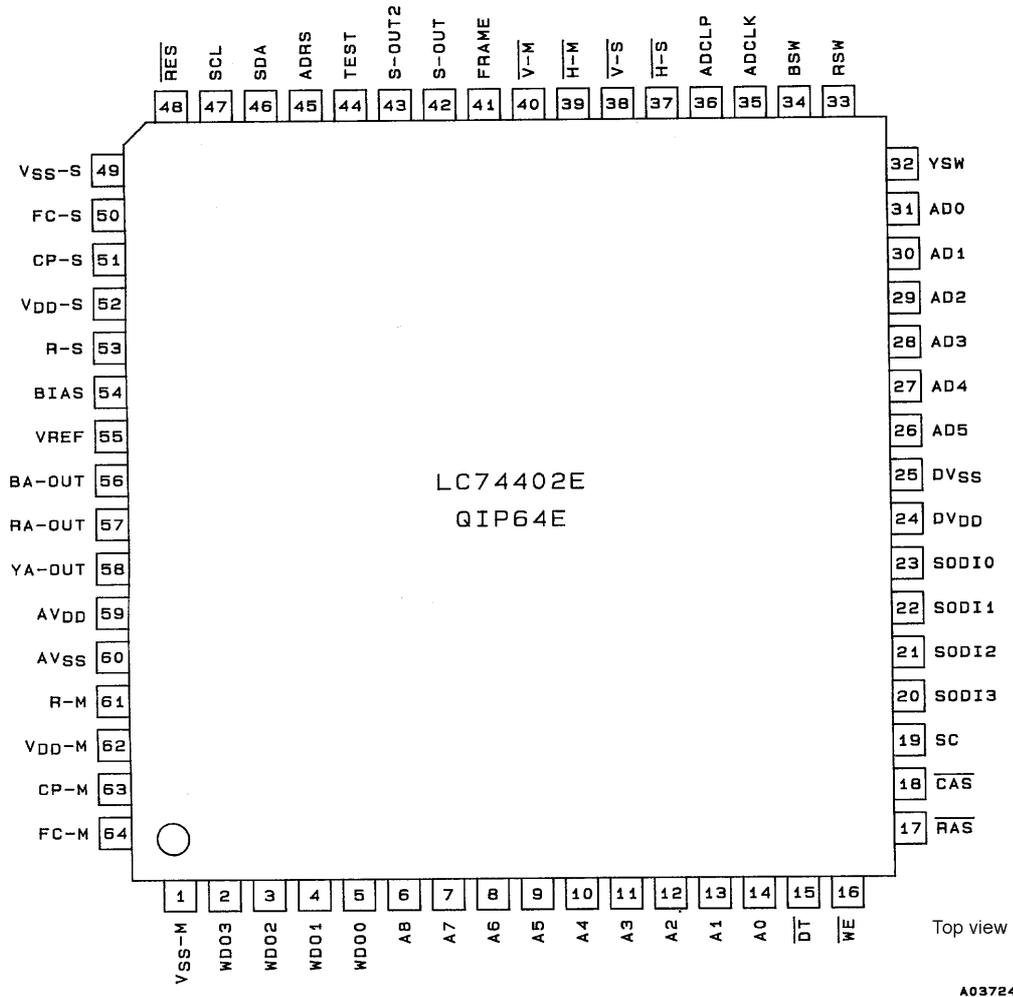


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# LC74401E, 74402, 74402E



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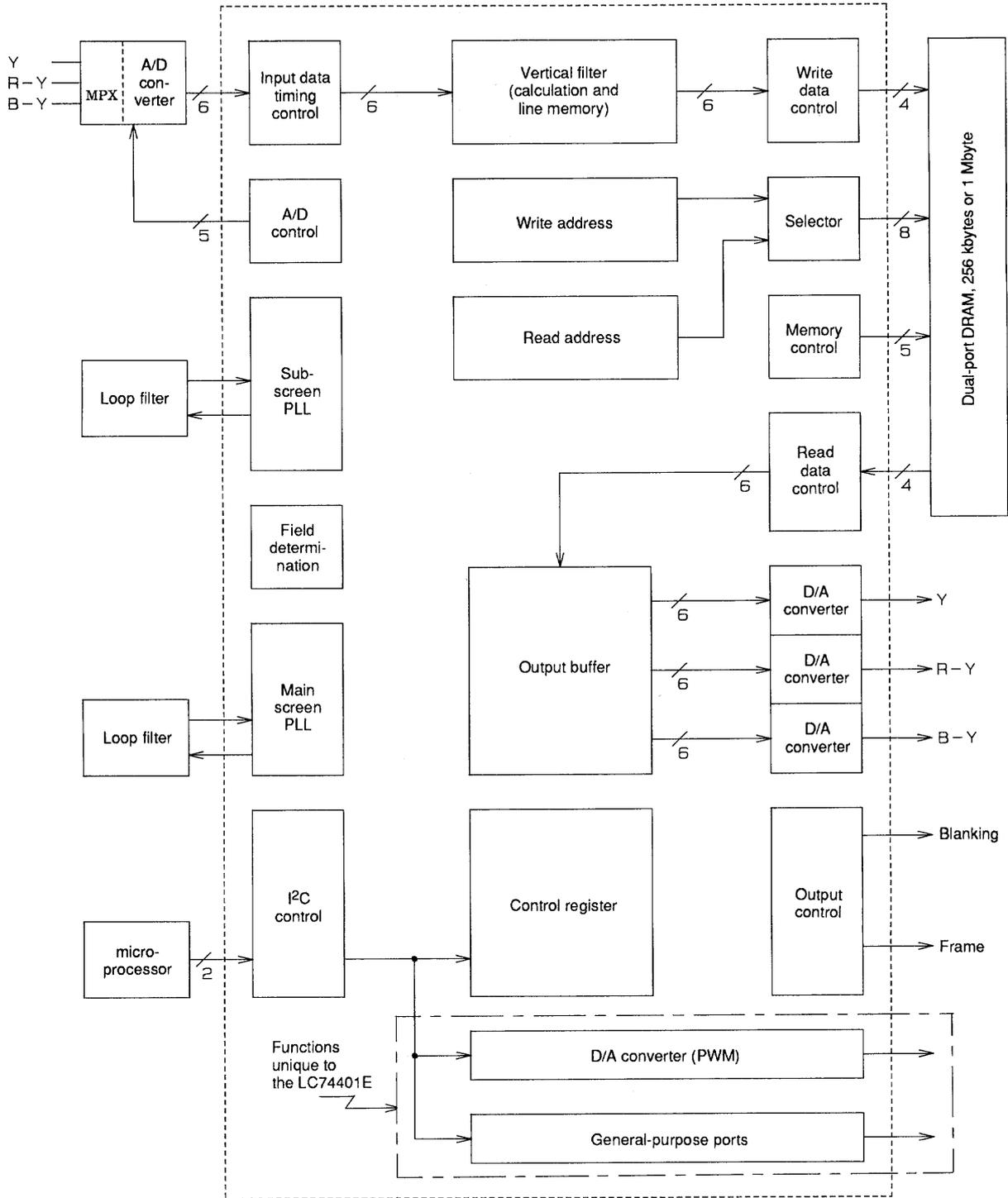


Top view

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LC74401E, 74402, 74402E

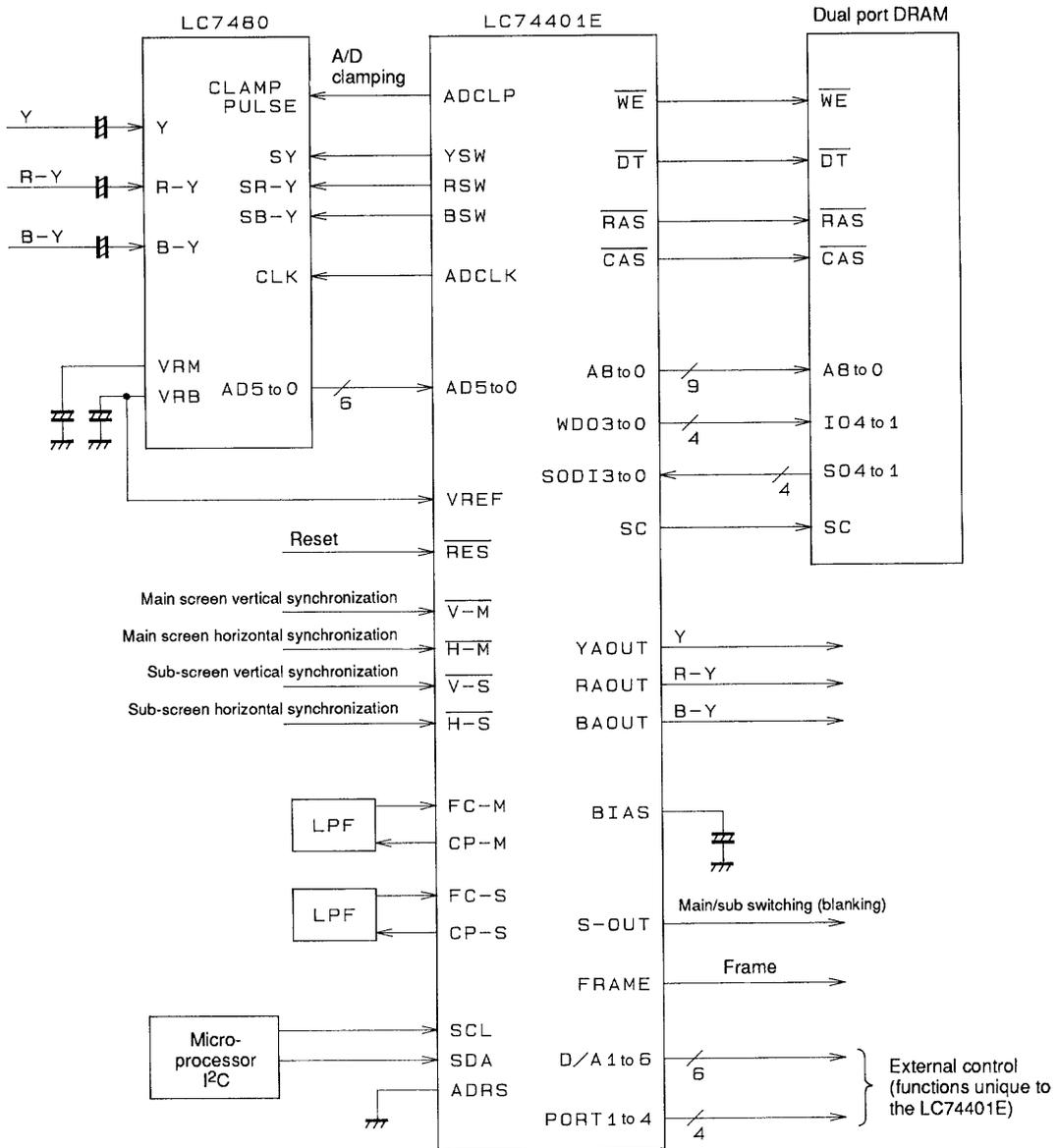
Block Diagram



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LC74401E, 74402, 74402E

Component-Type PIP System Structure Based on the LC74401E/2/2E and the LC7480



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## Functional Overview

1. Reduction options  
Vertical: Selectable 1/2, 1/3 and 1/4 reduction vertical filter coefficients.  
Horizontal: (1/1) to 2/3 to (1/2) to 1/3 to (1/4) to 1/6. Intermediate values are implemented using the aspect correction function.
2. Number of sub-screens  
With 1 Mb of memory: 1 to 4 or (8). \* Values in parentheses are for SPLIT mode, where the image quality is reduced.  
With 256 kb of memory: 1 or (2).
3. Static images  
With 1 Mb of memory: Frame static image (supported with 2 or fewer screens) or field static images  
With 256 kb of memory: Field static image
4. Display position  
Screen A: Fixed positions in the four corners  
Screen B: Free positioning (Specified by 8 bits in each of the vertical and horizontal directions.)
5. Frame
  - On/off selectable
  - Two types that differ by insertion method
    - Pin frame: The frame position is specified by a high level pin output. (application frame insertion)
    - D/A frame: A 50% white or arbitrary color overlapped on the Y, R-Y, and B-Y video signals.
6. Wipe  
Twelve types
7. Blanking size  
The vertical and horizontal directions can be specified independently (6 bits each)  
Sixteen forms can be specified.
8. Blue background  
The sub-screen can be set to all blue or all black.
9. Memory clear  
Sets the data written to video memory to a fixed value corresponding to a 25% white color.
10. Wide-screen TV support
  - Aspect correction function
  - Subtitle shifting  
The subtitle area can be trimmed and displayed as a sub-screen.  
The vertical reduction ratio can be set independently to 1/4, 1/3, or 1/2. The horizontal reduction can be set to values up to 1/1 using mode 2E.
11. Support for NTSC, PAL, and multi-mode (NTSC-PAL) products
12. External control functions using an I<sup>2</sup>C interface (LC74401E only)
  - Six 8-bit D/A converter circuits built-in (PWM)
  - Four general-purpose ports built-in
13. Setting adjustments  
Fine adjustment of various settings, including sub-screen position displacement and color shift is supported.

**Sub-screen Size**

The vertical and horizontal directions are controlled independently.

1. Vertical size

- 1/3 to (3) scan lines are compressed to a single scan line
- 1/4 to (4) scan lines are compressed to a single scan line

2. Horizontal size

- 1/3 to A/D clock: D/A clock = 1:3
  - 1/6 to A/D clock: D/A clock = 1:6
- The data required for 1/6 reduction is one half that for 1/3 reduction.

- Aspect correction function

The horizontal direction size is adjusted by changing the VCO oscillator frequency (system clock).

This can be adjusted from -30% to +30%.

However, care is required when using this function. See the Application Manual for details.

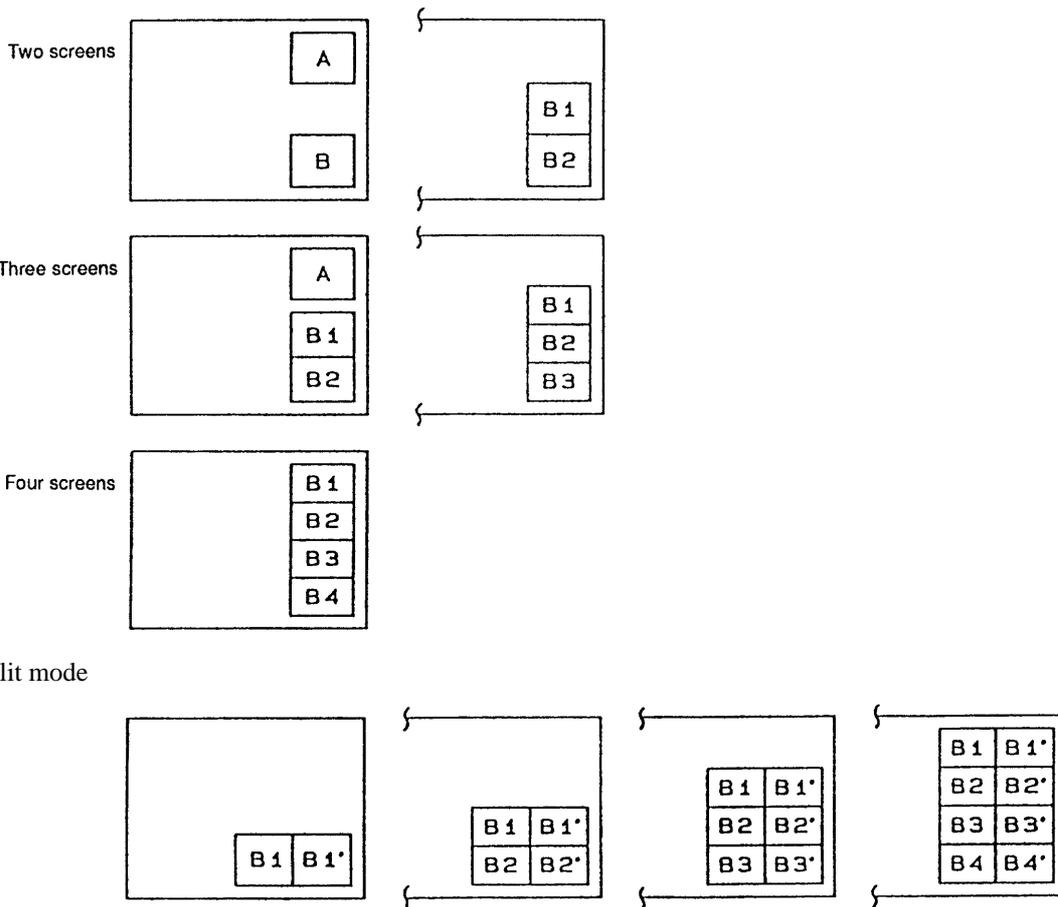
- 2E mode

If 2E mode is used when 1/3 size is selected, the horizontal direction is expanded by a factor of two.

This is normally used only for special functions such as split mode.

**Number of Sub-screens**

Between one and eight sub-screens can be specified (when 1 Mb of VRAM is used).

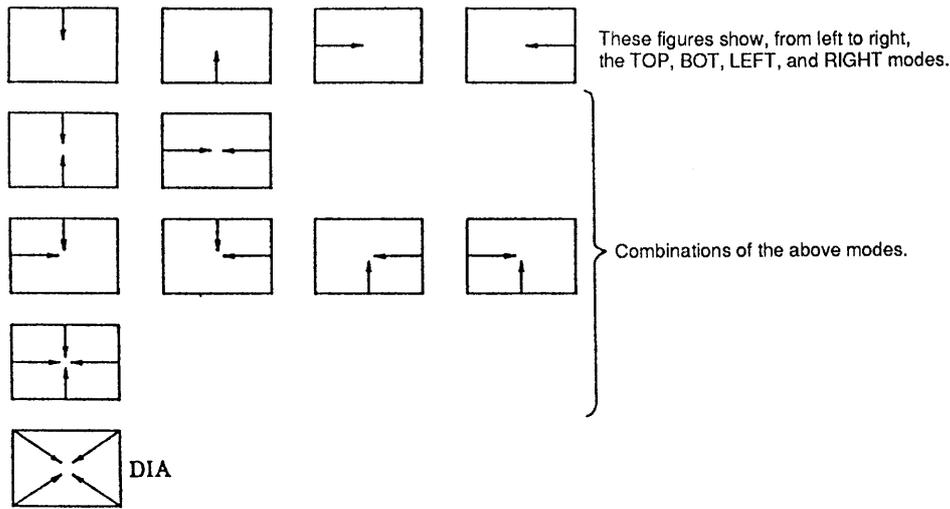


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Refer to the Application Manual for details on using these modes.

### Wipe Function

Wipe operation can be set in the top, bottom, left, and right directions, and in the diagonal direction independently.



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After a wipe mode has been set up, it operates automatically each time a sub-screen is switched on or off.

### Display Area Function

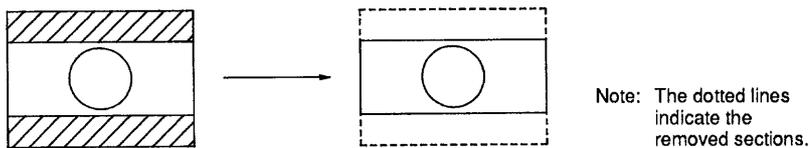
This function controls the blanking area.

The vertical direction and horizontal direction can be set up independently.

The operating mode is set by setting the wipe function TOP, BOT, LEFT, or RIGHT mode.

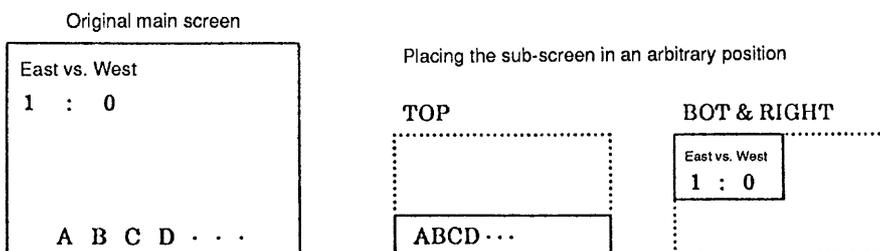
### Application Example

1. Excluding the masked portion of the letter box screen



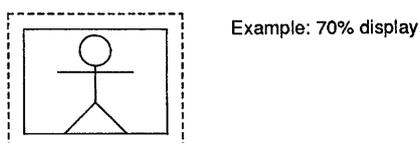
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2. Subtitle display



3. Small display

Reduces the portion of the main screen that is hidden.



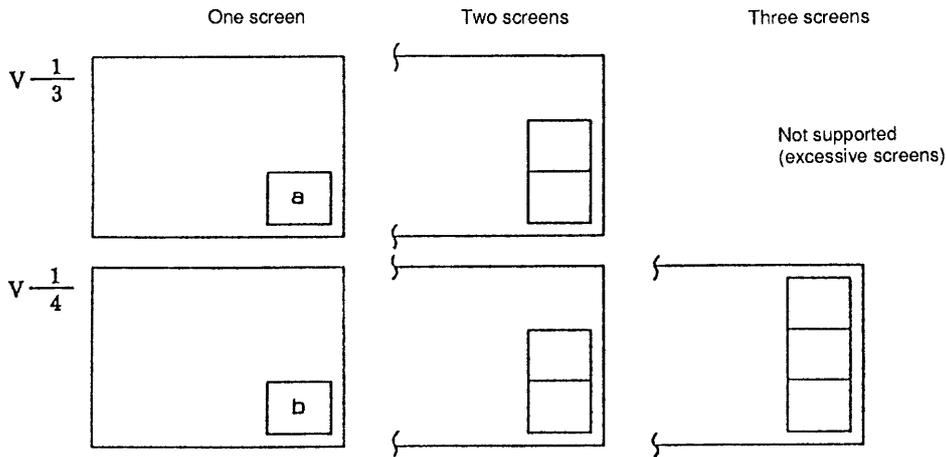
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**Multi-mode**

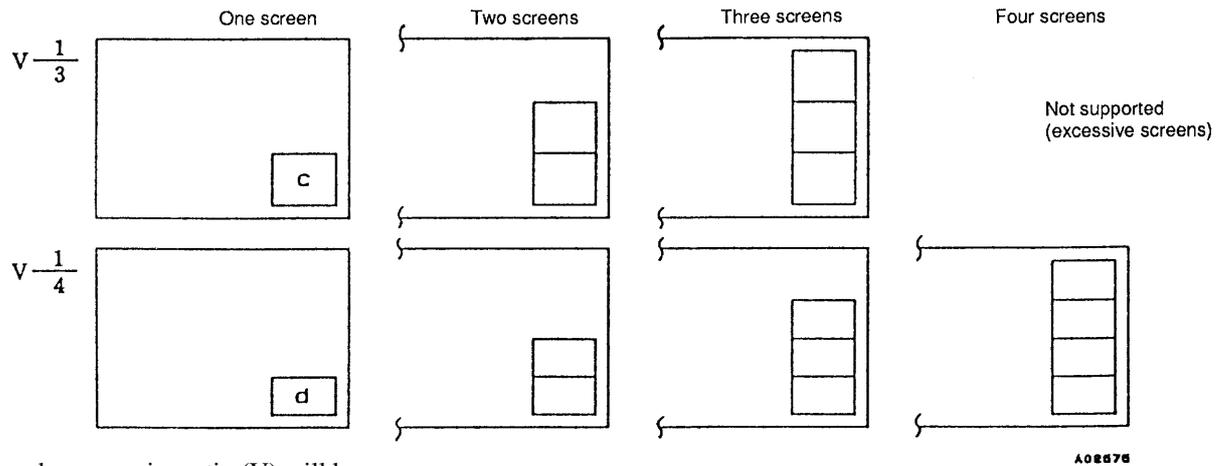
1. When 1 Mb of VRAM is used

- Frame memory processing (FRM = high)
  - Dynamic images: Frame display (MUL = high, overrun phenomenon occurs)
  - Static images: Frame display
- Field memory processing (FRM = low, FILD = high)
  - Dynamic images: Field display (overrun phenomenon occurs)
  - Static images: Field display

NTSC/PAL (= main/sub)



PAL/NTSC



The sub-screen size ratio (V) will be:

$$a : b : c : d = 1 : 0.8 : 0.77 : 0.58$$

If b and c are used, the size change can be held to 5%.

2. When 256 kb of VRAM are used

- Field memory processing (FRM = low, FILD = high)
  - Dynamic images: Field display (overrun phenomenon occurs)
  - Static images: Field display
- Only one screen can be displayed.

## LC74401E, 74402, 74402E

### Control Register Table

Address (HEX)	MSB 7	6	5	4	3	2	1	LSB 0	
01	SBY	STL	NT/PAL	MUL	FILD	FRM	P-NUM1	P-NUM0	Operating mode 1
02	WRT2	WRT1	WRT0	D-FIX	POUT-B	POUT-A	FVP	FHP	Operating mode 2
03	VP7	VP6	VP5	VP4	VP3	VP2	VP1	VP0	Screen B display position (V)
04	HP7	HP6	HP5	HP4	HP3	HP2	HP1	HP0	Screen B display position (H)
05	FRM-B	FRM-A	FRC-B	FRC-A	YFC5	YFC4	YFC3	YFC2	Frame setting, frame color (Y)
06	RFC5	RFC4	RFC3	RFC2	BFC5	BFC4	BFC3	BFC2	Frame color (R-Y, B-Y)
07	VDF-CO	HDF. 2E	CL-AJ1	CL-AJ0	FM-AJ1	FM-AJ0	YC-AJ1	YC-AJ0	Filter setting, adjustment 1
08	SIZE-V	SIZE-H	SPLIT	PLL7	PLL6	PLL5	PLL4	PLL3	Sub-screen size, PLL
09	WPE-B	WPE-A	TOP	BOT	LEFT	RIGHT	DIA	WP-MOD	Wipe setting
0A	PHP-M	PHP-S	VBS5	VBS4	VBS3	VBS2	VBS1	VBS0	Display area (V)
0B	DT-AJ1	DT-AJ0	HBS5	HBS4	HBS3	HBS2	HBS1	HBS0	Display area (H)
0C	TEXT	UPPER	M-BLUE	M-LVL	YL5	YL4	YL3	YL2	Subtitle display setting
0D	WV-AJ1	WV-AJ0	WH-AJ1	WH-AJ0	VP-AJ1	VP-AJ0	HP-AJ1	HP-AJ0	Display adjustment 2
0E	DAC1-7	DAC1-6	DAC1-5	DAC1-4	DAC1-3	DAC1-2	DAC1-1	DAC1-0	8-bit D/A converter 1 data
0F	DAC2-7	DAC2-6	DAC2-5	DAC2-4	DAC2-3	DAC2-2	DAC2-1	DAC2-0	8-bit D/A converter 2 data
10	DAC3-7	DAC3-6	DAC3-5	DAC3-4	DAC3-3	DAC3-2	DAC3-1	DAC3-0	8-bit D/A converter 3 data
11	DAC4-7	DAC4-6	DAC4-5	DAC4-4	DAC4-3	DAC4-2	DAC4-1	DAC4-0	8-bit D/A converter 4 data
12	DAC5-7	DAC5-6	DAC5-5	DAC5-4	DAC5-3	DAC5-2	DAC5-1	DAC5-0	8-bit D/A converter 5 data
13	DAC6-7	DAC6-6	DAC6-5	DAC6-4	DAC6-3	DAC6-2	DAC6-1	DAC6-0	8-bit D/A converter 6 data
14	0	0	0	0	PORT-4	PORT-3	PORT-2	PORT-1	General-purpose port
15	V-1/2	0	0	0	0	0	0	0	Test data

Note: 1. "0" indicates that the register value is set to 0.

2. When designing an application, be sure to read the Application Manual and check any relevant notes.

3. Addresses 0E to 14 are only valid for the LC74401E.

## LC74401E, 74402, 74402E

### Register Data Overview

Address	Symbol	Description
01	SBY	Standby mode (PLL circuit operating)
	STL	Static image (All writing stopped)
	NT/PAL	Format selection (high: NTSC, low: PAL)
	MUL	Multi-mode
	FILD	Field display selection
	FRM	Frame memory processing selection
	P-NUM1, 0	Number of screen B screens displayed (one to four screens)
02	WRT2 to 0	Dynamic image setting (write screen specification)
	D-FIX	Memory clear (fixes the memory write data)
	POUT-B, A	Sub-screen display on/off
	FVP, FHP	Four corner fixed position (screen A) specification
03	VP7 to 0	Screen B vertical position data
04	HP7 to 0	Screen B horizontal position data
05	FRM-B, A	D/A converter frame on/off
	FRC-B, A	D/A converter frame color register value specification
	YFC5 to 2	D/A converter frame color (Y)
06	RFC5 to 2	D/A converter frame color (R-Y)
	BFC5 to 2	D/A converter frame color (B-Y)
07	VDF-CO	Vertical filter coefficient specification
	HDF, 2E	HDF (horizontal filter on/off when SIZE-H = 1)
		2E mode (horizontal 2x expansion) on/off when SIZE-H = 0
	CL-AJ1, 0	A/D converter clamping position adjustment
	FM-AJ1, 0	D/A converter frame left/right thickness adjustment
YC-AJ1, 0	Position adjustment for C (R-Y, B-Y) with respect to Y	
08	SIZE-V	Vertical reduction specification H: 1/4 L: 1/3
	SIZE-H	Horizontal reduction specification H: 1/6 L: 1/3
	SPLIT	Split mode (Doubles the number of screens by splitting the sub-screens horizontally.)
	PLL7 to 3	PLL divisor value (10011 is the standard value)
09	WPE-B, A	Wipe or display area function enable
	TOP to DIA	Wipe or display area function shape specification
	WP-MOD	Wipe or display area function selection (high: wipe)
0A	PHP-M, S	Inversion or non-inversion of the field determination result
	VBS5 to 0	Display area value setting (vertical direction)
0B	DT-AJ1, 0	Memory control signal ( $\overline{DT}$ ) adjustment
	HBS5 to 0	Display area value setting (horizontal direction)
0C	TEXT	Partial display of an image reduced 1/2 in the vertical direction
	UPPER	Section specification for partial display in TEXT mode
	M-BLUE	Blue specification in masking mode
	M-LVL	Y level specification for the masked section
	YL-5 to 2	Masking level (data compared to the Y level)
0D	WV-AJ1, 0	Write vertical direction adjustment
	WH-AJ1, 0	Write horizontal direction adjustment
	VP-AJ1, 0	Display position vertical direction adjustment
	HP-AJ1, 0	Display position horizontal direction adjustment
0E	DAC1-7 to 0	External control D/A converter (8-bit PWM) data
0F	DAC2-7 to 0	
10	DAC3-7 to 0	
11	DAC4-7 to 0	
12	DAC5-7 to 0	
13	DAC6-7 to 0	
14	PORT-4 to 1	General-purpose port data
15	V-1/2	Vertical reduction specification 1/2

Note: The register functions at register addresses 0E to 14 can only be used with the LC74401E.

## LC74401E, 74402, 74402E

### Pin Functions

Pin No. 80E: LC74401E, 64S: LC74402, 64E: LC74402E

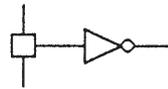
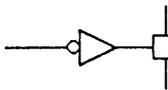
Pin No.			Symbol	I/O	Connection	Functions		Circuit type
64S	64E	80E						
48	40	53	$\overline{V-M}$	I	LA7403 or a sync separator IC	Main screen vertical synchronization signal (negative polarity)		
47	39	50	$\overline{H-M}$	I		Main screen horizontal synchronization signal (negative polarity)		
46	38	49	$\overline{V-S}$	I		Sub-screen vertical synchronization signal (negative polarity)		
45	37	48	$\overline{H-S}$	I		Sub-screen horizontal synchronization signal (negative polarity)		
55	47	61	SCL	I	Microprocessor	Serial clock	I <sup>2</sup> C	A02576
54	46	60	SDA	I/O		Serial data		
53	45	59	ADRS	I	V <sub>SS</sub>			
56	48	62	$\overline{RES}$	I	Initialization circuit	Reset		
52	44	57	TEST	I	V <sub>SS</sub>	Test (Tied to V <sub>SS</sub> in normal operation.)		
—	—	3	PORT1	O		General-purpose ports		
—	—	8	PORT2	O				
—	—	15	PORT3	O				
—	—	20	PORT4	O				
10	2	4	WDO3	O	Memory	Memory write data outputs		
11	3	5	WDO2	O				
12	4	6	WDO1	O				
13	5	7	WDO0	O				
14	6	9	A8	O	Memory	MSB	Address (A8 is left open when a 256 kbyte external memory is used.)	
15	7	11	A7	O				
16	8	12	A6	O				
17	9	13	A5	O				
18	10	14	A4	O				
19	11	16	A3	O				
20	12	17	A2	O				
21	13	18	A1	O				
22	14	19	A0	O	LSB			
23	15	21	$\overline{DT}$	O	Memory	Control signals		A02578
24	16	22	$\overline{WE}$	O				
25	17	25	$\overline{RAS}$	O				
26	18	26	$\overline{CAS}$	O				
27	19	27	SC	O				
28	20	28	SODI3	I	Memory	Memory read data inputs		
29	21	29	SODI2	I				
30	22	30	SODI1	I				
31	23	31	SODI0	I				
—	—	63	D/A1	O		PWM D/A converter output		
—	—	58	D/A2	O				
—	—	52	D/A3	O				
—	—	51	D/A4	O				
—	—	47	D/A5	O				
—	—	46	D/A6	O				

Continued on next page.

## LC74401E, 74402, 74402E

Continued from preceding page.

Pin No. 80E: LC74401E, 64S: LC74402, 64E: LC74402E

Pin No.			Symbol	I/O	Connection	Functions		Circuit type
64S	64E	80E						
34	26	34	AD5	I	LC7480	MSB	Inputs for A/D converted digital data	 A02577
35	27	35	AD4	I				
36	28	36	AD3	I				
37	29	37	AD2	I				
38	30	38	AD1	I				
39	31	39	AD0	I				
40	32	40	YSW	O	LC7480	Y signal selection	MPX switching signals	 A02578
41	33	42	RSW	O		R-Y signal selection		
42	34	43	BSW	O		B-Y signal selection		
43	35	44	ADCLK	O	LC7480	Sampling clock		
44	36	45	ADCLP	O	LC7480	Clamping pulse		
49	41	54	FRAME	O	LA7403	Frame pulse output		
50	42	55	S-OUT	O	LA7403	Main/sub switching signal		
51	43	56	S-OUT2	O	—	Control signal		
32	24	32	DV <sub>DD</sub>			Digital power supply (for logic circuits and line memory)		
33	25	33	DV <sub>SS</sub>					
2	58	74	YA-OUT	O	LA7403	Y signal	D/A converter outputs	
1	57	73	RA-OUT	O		R-Y signal		
64	56	72	BA-OUT	O		B-Y signal		
63	55	71	VREF	I	LC7480	D/A converter analog system settings		
62	54	70	BIAS	—	Capacitor			
3	59	75	AV <sub>DD</sub>			D/A converter analog system power supply		
4	60	76	AV <sub>SS</sub>					
7	63	79	CP-M	O	LPF	Charge pump output	Main screen synchronization VCO	
8	64	80	FC-M	I	LPF	Oscillator control voltage input		
5	61	77	R-M	—	Resistor	Oscillator range resistor		
6	62	78	V <sub>DD</sub> -M			Power supply		
9	1	2	V <sub>SS</sub> -M					
59	51	67	CP-S	O	LPF	Charge pump output	Main screen synchronization VCO	
58	50	66	FC-S	I	LPF	Oscillator control voltage input		
61	53	69	R-S	—	Resistor	Oscillator range resistor		
60	52	68	V <sub>DD</sub> -S			Power supply		
57	49	65	V <sub>SS</sub> -S					

## Specifications

**Absolute Maximum Ratings at  $T_a = 25 \pm 8^\circ\text{C}$ ,  $V_{SS} = 0\text{ V}$**

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	$V_{DD\text{ max}}$		-0.3 to +7.0	V
Input voltage	$V_{IN}$		-0.3 to $V_{DD} + 0.3$	V
Output voltage	$V_{OUT}$		-0.3 to $V_{DD} + 0.3$	V
Allowable power dissipation	$P_{d\text{ max}}$		350	mW
Operating temperature	$T_{opr}$		-10 to +70	$^\circ\text{C}$
Storage temperature	$T_{stg}$		-55 to +125	$^\circ\text{C}$

## LC74401E, 74402, 74402E

### Allowable Operating Ranges at $T_a = -10$ to $+70^\circ\text{C}$ , $V_{SS} = 0$ V

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Supply voltage	$V_{DD}$		4.5	5.0	5.5	V
Input high level voltage	$V_{IH1}$	CMOS level	$0.7 V_{DD}$			V
	$V_{IH2}$	TTL level	2.2			V
Input low level voltage	$V_{IL1}$	CMOS level			$0.3 V_{DD}$	V
	$V_{IL2}$	TTL level			0.8	V
Reference voltage	$V_{REF}$		3.4	$0.8 V_{DD}$	$V_{DD}$	V

### Electrical Characteristics at $T_a = 25 \pm 2^\circ\text{C}$ , $V_{DD} = 5$ V $\pm 10\%$ , $V_{SS} = 0$ V

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Output high level voltage	$V_{OH1}$	Pins CP-M and CP-S: $I_{OH} = -1$ mA	$V_{DD} - 1$			V
	$V_{OH2}$	Pins other than CP-M and CP-S: $I_{OH} = -1$ mA	$V_{DD} - 1$			V
Output low level voltage	$V_{OL1}$	Pins CP-M and CP-S: $I_{OL} = 1$ mA			1.0	V
	$V_{OL2}$	Pins other than CP-M and CP-S: $I_{OL} = 2$ mA			0.4	V
	$V_{OL3}$	With the SDA pin output active: $I_{OL} = 3$ mA			0.4	V
Operating current drain*1	$I_{DD}D$	The $DV_{SS}$ pin		25		mA
	$I_{DD}A$	The $AV_{SS}$ pin		21		mA
	$I_{DD}M$	The $V_{SS}M$ pin		2		mA
	$I_{DD}S$	The $V_{SS}S$ pin		2		mA
Quiescent current	$I_{DD}S$	RES: $V_{SS}$ with DC signals on the input pins and no output load.			10	$\mu\text{A}$
Input leakage current	$I_{LK}$	$V_I = V_{DD}, V_{SS}$	-1		+1	$\mu\text{A}$
Output leakage current	$I_{OZ}$	Pins CP-M and CP-S; $V_I = V_{DD}, V_{SS}$	-1		+1	$\mu\text{A}$
D/A converter output resistance	$R_{DA}$			150		$\Omega$

Note: 1. Test conditions as follows:

RES:  $V_{DD}$ ,  $V_M$ ,  $V_S$ : 60 Hz,  $H-M$ ,  $H-S$ : 15 kHz

A/D converter data: 1010..., No output load

2. There are four power supply pin systems.

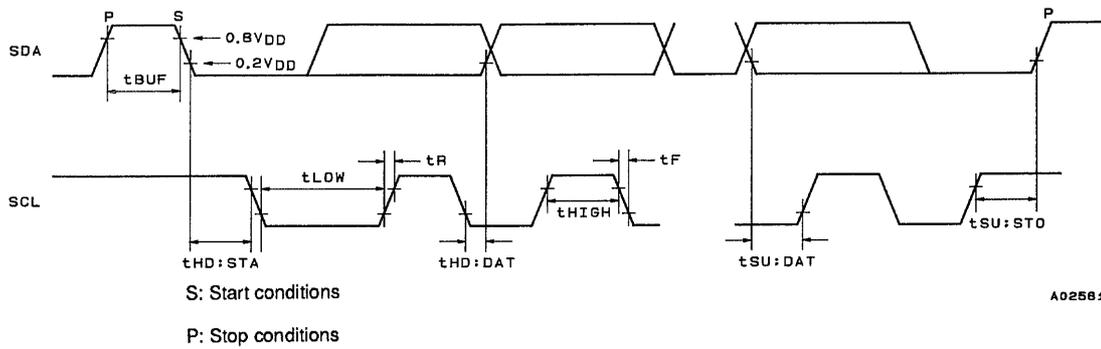
The supply voltages must all be equal, i.e.,  $DV_{DD} = AV_{DD} = V_{DD}M = V_{DD}S$ . Descriptions are in terms of  $V_{DD}$ .

The grounds must all be equal, i.e.,  $DV_{SS} = AV_{SS} = V_{SS}M = V_{SS}S$ . Descriptions are in terms of  $V_{SS}$ .

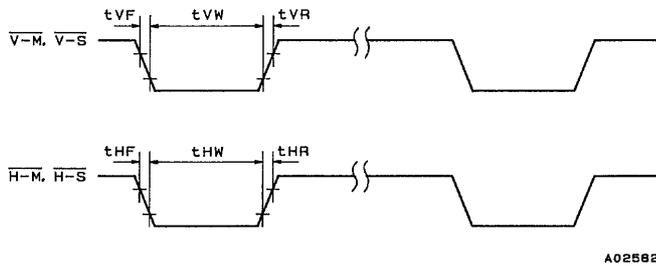
### Switching Characteristics at $T_a = 25 \pm 2^\circ\text{C}$ , $V_{DD} = 5$ V $\pm 10\%$ , $V_{SS} = 0$ V

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Vertical synchronization signal						
Pulse width	$t_{VW}$		1			$\mu\text{s}$
Rise time	$t_{VR}$				50	ns
Fall time	$t_{VF}$				50	ns
Horizontal synchronization signal						
Pulse width	$t_{HW}$		1			$\mu\text{s}$
Rise time	$t_{HR}$				50	ns
Fall time	$t_{HF}$				50	ns
I <sup>2</sup> C timing						
SCL frequency	$f_{SCL}$				100	kHz
Bus release time	$t_{BUF}$		4.7			$\mu\text{s}$
Start hold time	$t_{HD}$ : STA		4.0			$\mu\text{s}$
SCL low period	$t_{LOW}$		4.7			$\mu\text{s}$
SCL high period	$t_{HIGH}$		4.0			$\mu\text{s}$
Data hold time	$t_{HD}$ : DAT		0			$\mu\text{s}$
Data setup time	$t_{SU}$ : DAT		250			ns
Rise time	$t_R$				1000	ns
Fall time	$t_F$				300	ns
Stop setup time	$t_{SU}$ : STO		4.0			$\mu\text{s}$

## LC74401E, 74402, 74402E



### Synchronization Signal



### Sub-Screen Digital Processing Specifications

Item		NTSC ( $f_H = 15734 \text{ Hz}$ )	PAL ( $f_H = 15625 \text{ Hz}$ )
Sampling	Sequence	Y, R-Y, Y, B-Y, Y, -, Y, -, ...	
	Frequency	$640 f_H$	
	$f_T$ (MHz)	10.070	10.000
	Y only	$320 f_H$	
	$f_{TY}$	5.035	5.000
	R-Y only	$80 f_H$	
$f_{TR}$	1.258	1.250	
B-Y only	$80 f_H$		
$f_{TB}$	1.258	1.250	
Quantization bits		6 bits	
D/A converter clock (MHz)*1	Y signal	$960 f_H$	
	$f_{CY}$	15.105	15.000
	R-Y signal	$240 f_H$	
	$f_{CR}$	3.776	3.750
B-Y signal	$240 f_H$		
$f_{CB}$	3.776	3.750	
Write	Horizontal dots	384	
	Y only	256	
	R-Y only	64	
	B-Y only	64	
Vertical H count	80	84	
Read and display*2	Horizontal dots	370	
	Y only	250	
	R-Y only	60	
	B-Y only	60	
	Vertical H count	77	83

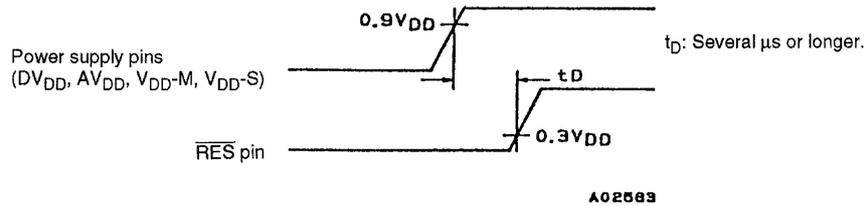
Note: 1. When the PLL divisor has the standard value, i.e., PLL7 to PLL3 = 10011.

2. Approximate values.

(The number of horizontal dots depends on the frame width adjustment, and the vertical H count depends on address correction.)

**Initialization**

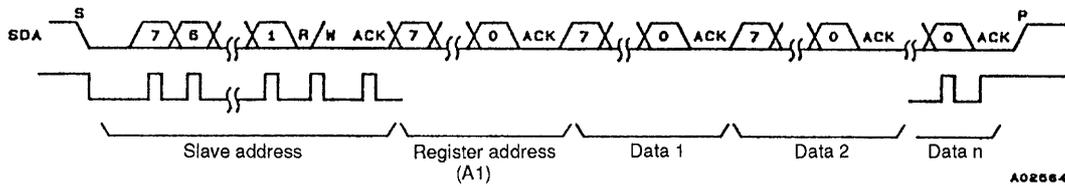
1.  $\overline{\text{RES}}$  pin: Reset  
The RES pin must be set low when power is first applied.



2. Internal control registers  
These LSIs go to the standby state (SBY = high) after a reset. When developing microprocessor software, be sure to send data to all registers. Also be sure to send zero data to the zero registers at addresses 14H and 15H.

**I<sup>2</sup>C Control**

Data format



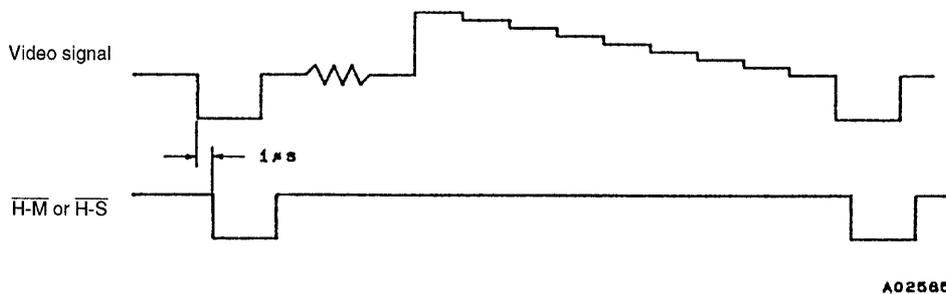
Data 1 is stored at register address A1. For data 2, A1 is incremented and data 2 is stored at A1 + 1.

Slave Address

A6	A5	A4	A3	A2	A1	A0	R/W
0	0	1	0	0	1	1	$\nearrow$

**Synchronization Signal Input**

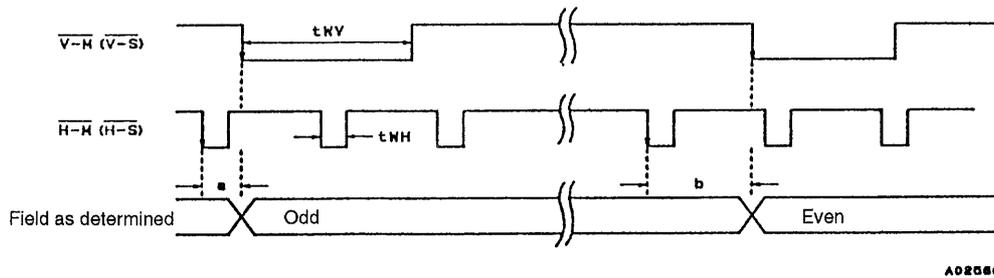
1. Sync separator  
The LC74401E requires sync separated (including AFC processing) V and H signals for both the main and sub-screens. Since V is used for frame determination and H is used as the PLL reference signal, these signals must be input reliably.
  - The standard values are set up assuming that the  $\overline{\text{H-M}}$  and  $\overline{\text{H-S}}$  inputs are delayed about 1  $\mu\text{s}$  from the video signal horizontal synchronization signal.



- Equalizing pulses must be removed.
- Since noise in the synchronization signal will disrupt the screen image, care must be used in the layout of these lines.
- We recommend turning off sub-screen display when the synchronization signals are unstable, since such instability can disrupt the sub-screen image.

2. Field determination circuit

Since the field is determined by the phase difference between the falling edges of the V and H signals, these signals must be input with the timing shown in the figure.

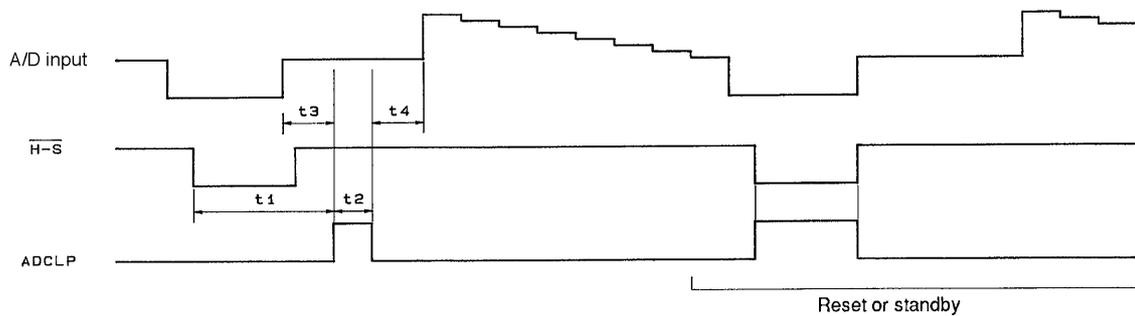


Here, a and b must be: a = 0.02 to 0.40 H, b = 0.60 to 0.98 H.  
The synchronization signal pulse widths are:  $t_{KV} > 1 \mu s$ ,  $t_{WH} > 1 \mu s$ .

Clamping Pulses

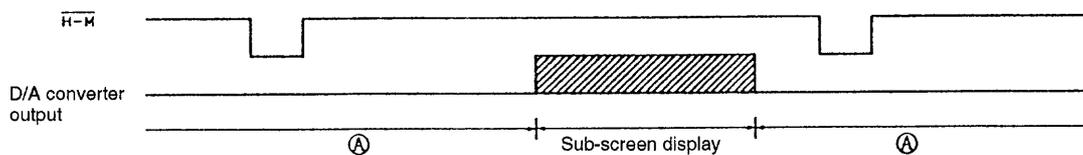
1. A/D converter clamping

Since clamping pulses are output with the timing shown in the figure, they must set to fall in the pedestal range. On a reset or during standby mode, the  $\overline{H-S}$  input signal becomes a positive polarity signal, and is output as such.



Note: Here, t3 and t4 must be:  $t3 > 0 \mu s$ ,  $t4 > 0.5 \mu s$ .

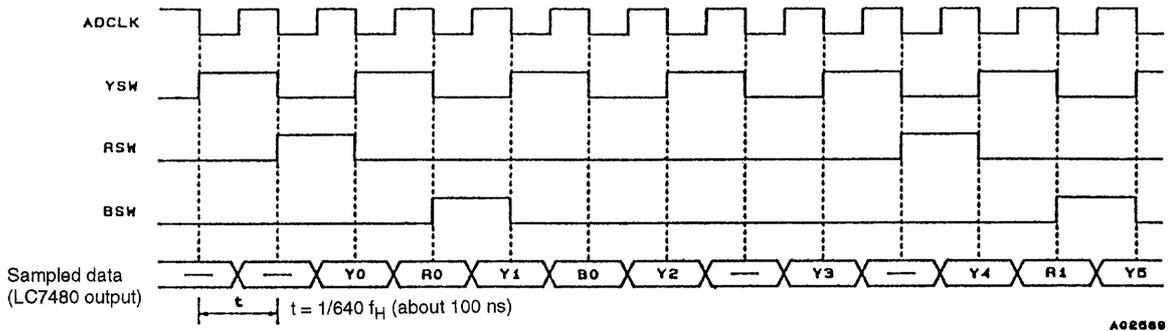
2. D/A converter clamping



The digital data for the regions A is as follows:  
Y D/A converter input: 000000  
R-Y D/A converter input: 100000  
B-Y D/A converter input: 100000  
Clamping is applied on the main screen horizontal synchronization signal.

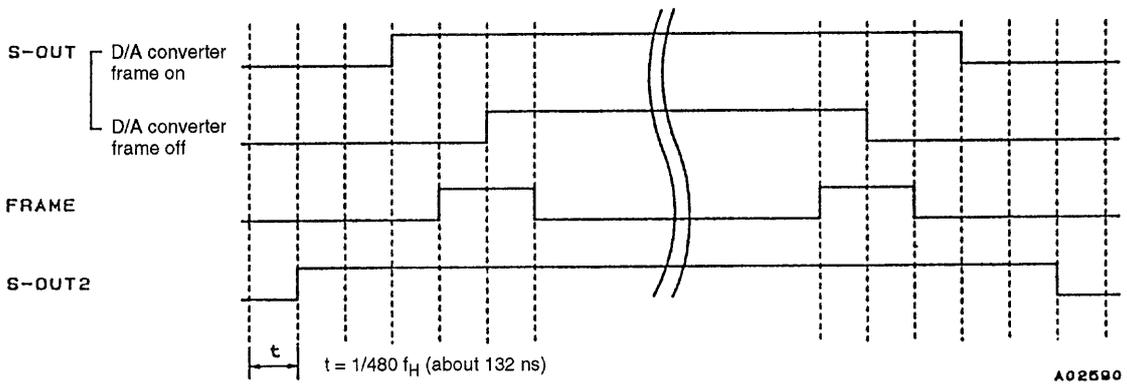
External Control Output Timing

1. A/D converter (LC7480) related signals



Note: Since these are high speed signals, care must be taken to keep their lines as short as possible.

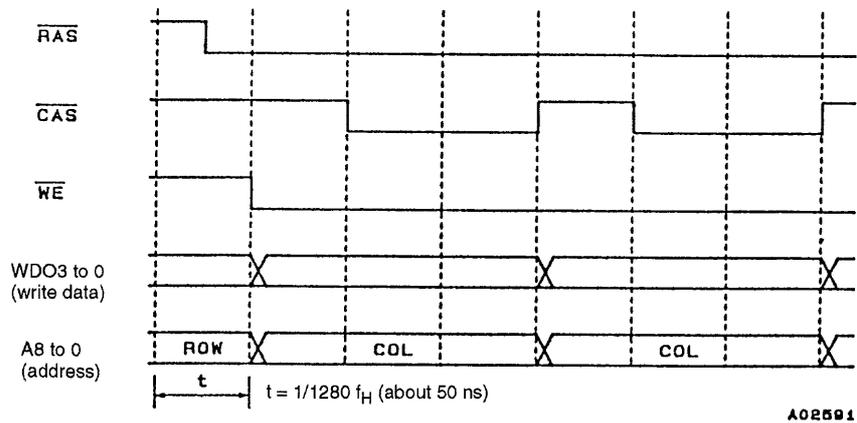
2. Clamping related signals



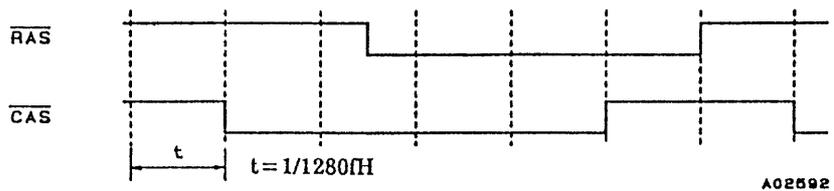
Note: The FRAME signal is only output in D/A converter frame off mode.

3. Video memory related signals

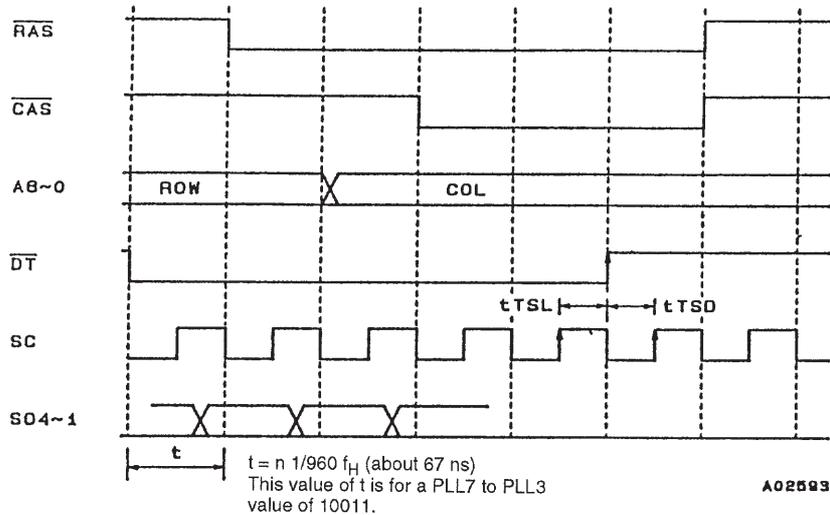
- Data write signals (page mode)



- Refresh signals (CAS before RAS)



3. Data transfer → serial read



- Note: 1. Since these are high speed signals, care must be taken to keep their lines as short as possible.  
 2. Contact your Sanyo representative when determining the memory to use.

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